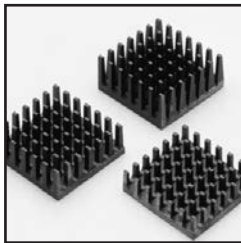


# HEAT SINKS FOR BGAs, SUPER BGAs, PBGAs, and FPBGAs



## 625 SERIES Omnidirectional Pin Fin Heat Sink for BGAs

Standard P/N	Base Dimensions in. Sq.	Fin Height "A" in. (mm)	Typical Applications	Weight lbs. (grams)
625-25AB	.984 (25)	0.250 (6.4)	25 mm BGA	.012 (5.45)
625-35AB	.984 (25)	0.350 (8.9)	25 mm BGA	.014 (6.36)
625-45AB	.984 (25)	0.450 (11.4)	25 mm BGA	.018 (8.17)
625-60AB	.984 (25)	0.600 (15.2)	25 mm BGA	.030 (13.62)

Material: Aluminum, Black Anodized

The 625 Series is an omnidirectional pin fin heat sink for both natural and forced-convection applications.

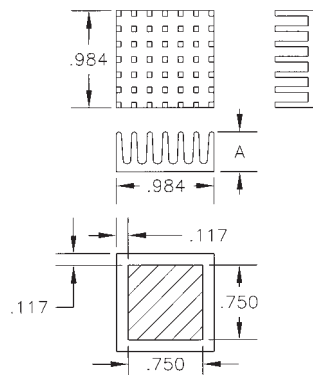
Applications include network routers and switches, high-resolution printers, digital cameras, consumer video games, digital video disks (DVD) and global positioning systems (GPS).

### PRODUCT FEATURES

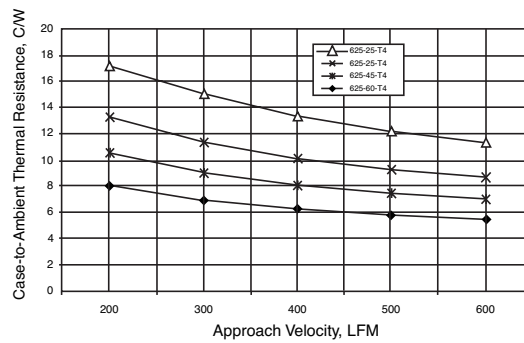
- Available in four standard heights, .25 inch, .35 inch, .45 inch, and .60 inch.
- Available with pressure sensitive adhesives for quick and easy mounting. See Page 3

### MECHANICAL DIMENSIONS

### 625 SERIES



### 625 THERMAL PERFORMANCE



Dimensions: in.